

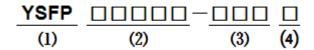
Features

- Assemblage design, sturdy structure.
- High inductance, high current, low magnetic loss, low ESR, small parasitic capacitance.
- Flat wire winding, achieve alow D.C.Resistance.
- Temperature rise current and saturation current is less influenced by environment.
- Operating temperature range:-40°C ~ +125°C.

Applications

- Low profile, high current power supplies.
- Battery powered devices.
- DC/DC converters in distributed power systems.
- DC/DC converters for field programmable gate array.

Product Identification



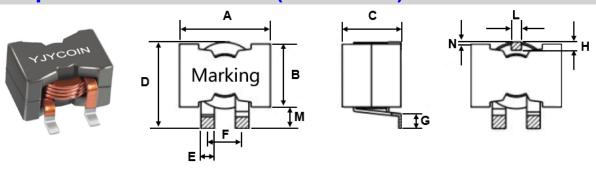
(1) : Type

(2): Dimensions

(3): Inductance value

(4) : Inductance Tolerance: $M=\pm20\%$, $K=\pm10\%$, $J=\pm5\%$

Shapes and Dimensions (Unit: mm)



| TYPE | A Max. | B Max. | C Max. | D Max. | E | F | G Min. | Н | ٦ | М | Z |
|-----------|-----------|-----------|-----------|-----------|---------|--------|-----------|-----|-----|---------|-----|
| YSFP2918S | 28.0 | 19.7 | 18.5 | 27.0 | 4.0±0.3 | 10±0.5 | 3.8 | 3.5 | 3.0 | 6.5±1.0 | 0.5 |

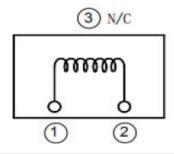


■ Electrical requirements

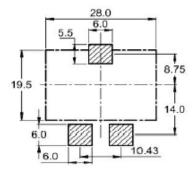
| Part Number | L (uH) | Test Freq. | DCR Max.(mΩ) | I sat (A) | I rms (A) |
|----------------|---------|--------------|--------------|-----------|-----------|
| YSFP2918S-2R2M | 2.2±20% | 100KHz/0.25V | 2.5 | 100 | 30 |
| YSFP2918S-3R3M | 3.3±20% | 100KHz/0.25V | 2.5 | 93 | 30 |
| YSFP2918S-4R7M | 4.7±20% | 100KHz/0.25V | 2.5 | 63 | 30 |
| YSFP2918S-6R8M | 6.8±20% | 100KHz/0.25V | 2.5 | 46 | 30 |
| YSFP2918S-100M | 10±20% | 100KHz/0.25V | 2.5 | 31 | 30 |
| YSFP2918S-150M | 15±20% | 100KHz/0.25V | 2.5 | 21 | 30 |
| YSFP2918S-220M | 22±20% | 100KHz/0.25V | 2.5 | 14 | 30 |
| YSFP2918S-330M | 33±20% | 100KHz/0.25V | 2.8 | 8.7 | 30 |

- ※ All test data is based on 25 °C ambient.
- \aleph DC current(A) that will cause an approximate Δ T40 °C.
- X DC current(A) that will cause L0 to drop approximately 30% Typ.
- ※ The part temperature (ambient + temp rise) should not exceed 125℃ under worst case operating conditions. Circuit design,component.PWB trace size and thickness,airflow and other cooling provision all affect the part temperature.Part temperature should be verified in the den application.

Electrical schematics

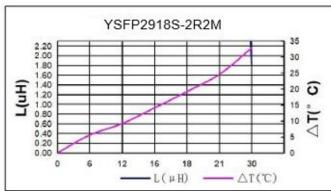


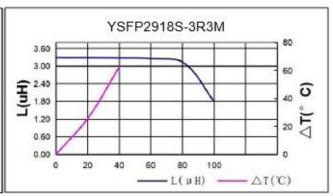
Recommended PCB Layout

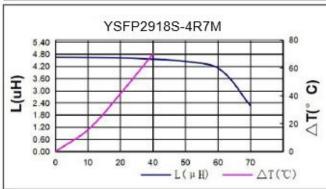


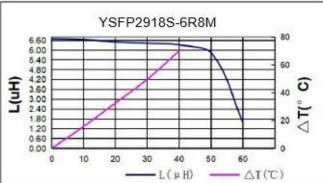


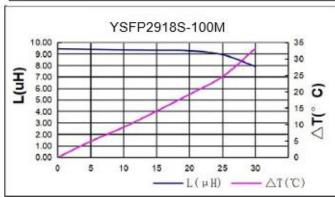
Saturation current VS temperature rise current curve

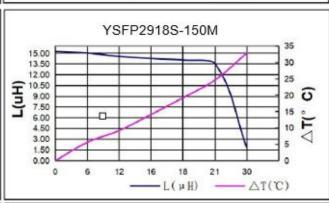


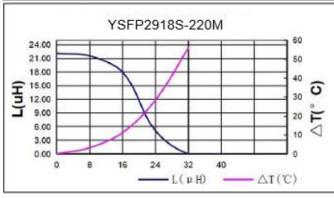


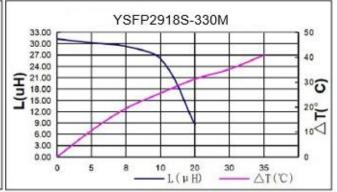












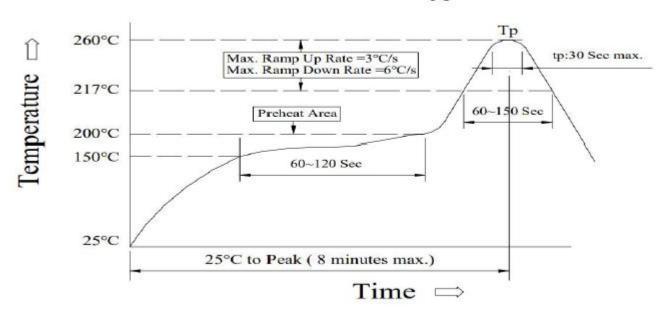


Reliability

| Item | Specification and Requirement | Test Method | | |
|-------------------------|--|--|--|--|
| | Terminals area must have 050/ min colder | Solder heat proof: | | |
| Solder a bility test | Terminals area must have 95% min solder | ①Preheating:160±10℃ for 90 seconds | | |
| | coverage | ②Retention time:245±5℃ for 2±0.5 seconds | | |
| | | ① Vibration frequency:(10Hz to 55Hz to | | |
| Vibration test | lado atama alama Nikhim 150/ Mikhank | 10Hz) in 60 seconds as a period | | |
| | Inductance change:Within±5% Without | ② Vibration time: Reriod cycled for 2 hours | | |
| | Mechanical damage such as break | in each of 3 mutual perpendicular directions. | | |
| | | ③ Amplitude:1.5mm Max. | | |
| | | ① Peak value:100G. | | |
| 0 | Inductance change: Within±5% Without | ② Duration of pulse:11ms. | | |
| Shock test | Mechanical damage such as break | ③ Times in each positive and negative | | |
| | | direction of 3 mutual perpendicular directions | | |
| | | ① Repeat 100 cycle as follow (-55±2℃ | | |
| | | 30±3 minutes),Room temperature,5 minutes | | |
| The success of the self | Inductance change: Within±5% Without | (+125±2°ℂ,30±3 minutes) | | |
| Thermal shock | Mechanical damage such as break | ② Recovery:48+4/-0 hours of recovery | | |
| | | Under the standard condition after the test. | | |
| | | (see Note 1) | | |
| Llink town and we | laductores alegans Mithin 150/ Mithaut | ① Environment condition:85±2℃ | | |
| High temperature | Inductance change: Within±5% Without | Applied current:Rated current | | |
| life test | Mechanical damage such as break | ② Duration:1000+4/-0 hours(see Note 1) | | |
| | | ① Environment condition:60±2℃ | | |
| Humidity | Inductance change: Within±5% Without | Humidity:90-95% | | |
| Resistance | Mechanical damage such as break | Applied current:Rated current | | |
| | | ② Duration:1000+4/-0 hours(see Note 1) | | |
| Low temperature | Inductance change: Within±5% Without | Store temperature -55±±2℃ for total | | |
| life test | Mechanical damage such as break | 1000+4/-0 hours | | |
| High temperature | Inductance change: Within±5% Without | Store temperature +125±2℃for total | | |
| life test | Mechanical damage such as break | 1000+4/-0 hours | | |

■ Reflow Profile

Power Choke Coil Type



■ Reflow Soldering Method

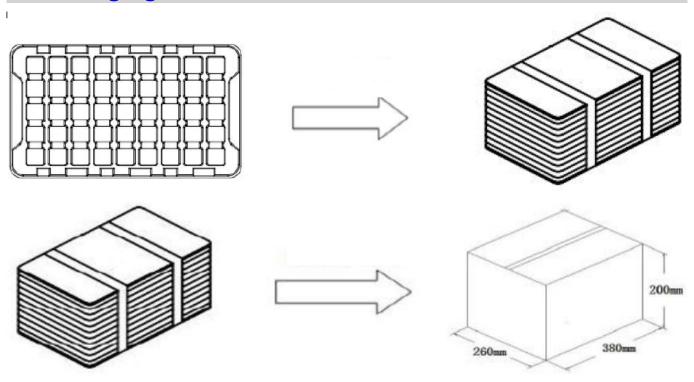
| Poflow Soldering | Tp:255 ~ 260°C Max. 30 seconds(tp) | | | |
|------------------------------|------------------------------------|--|--|--|
| Reflow Soldering | 217℃ 60 ~ 150 seconds | | | |
| Pre-Heat | 150 ~ 200°C 60 ~ 120 seconds | | | |
| Time 25℃ to peak temperature | 8 minutes Max. | | | |

Soldering iron method

350±5°C Max.3 seconds.



Packaging



| Product Series | Quantity/Tray | Quantity/Carton |
|----------------|---------------|-----------------|
| YSFP2918S | 40 PCS | 280 PCS |